Contents STW70N60M2-4

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STW70N60M2-4 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
I_D	Drain current (continuous) at T _C = 25 °C	68	Α
ΙD	Drain current (continuous) at T _C = 100 °C	43	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	272	Α
P _{TOT}	Total dissipation at T _C = 25 °C	450	W
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by $T_{\text{jmax}})$	10	А
Eas	Single pulse avalanche energy (starting $T_j=25^{\circ}C$, $I_D=10$ A; $V_{DD}=50$ V)	1500	mJ
dv/dt (2)	Peak diode recovery voltage slope	15	V/ns
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	- 55 to 150	°C
T_{j}	Operating junction temperature range		

Notes

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.28	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/W

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \le 68$ A, di/dt = 400 A/ μ s, $V_{DS(peak)} < V_{(BR)DSS}$, $V_{DD} = 400$ V

 $^{^{(3)}}V_{DS} \le 480 \text{ V}$

2 **Electrical characteristics**

(T_C = 25 °C unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0$	600			٧
	Zero gate voltage	$V_{GS} = 0$, $V_{DS} = 600 \text{ V}$			1	μΑ
I _{DSS}	drain current	$V_{GS} = 0$, $V_{DS} = 600 \text{ V}$, $T_{C}=125 ^{\circ}\text{C} ^{(1)}$			100	μΑ
Igss	Gate-body leakage current	V _{DS} = 0, V _{GS} = ±25 V			±10	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 34 A		0.030	0.040	Ω

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	5200	ı	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,		250	ı	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	5	-	pF
Coss eq. (1)	Equivalent output capacitance	$V_{GS} = 0$, $V_{DS} = 0$ to 480 V	-	395	-	pF
R _G	Intrinsic gate resistance	f = 1 MHz, I _D =0 A		3.3	ı	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 68 \text{ A},$	-	118	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	25	-	nC
Q _{gd}	Gate-drain charge	(see Figure 15: "Gate charge test circuit")	-	47	-	nC

Notes:

Table 6: Switching times

rable of emiterning times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 34 \text{ A},$	ı	30	-	ns	
tr	Rise time	R _G = 4.7 Ω, V _{GS} = 10 V (see Figure 14: "Switching times test circuit for resistive		10	-	ns	
t _{d(off)}	Turn-off-delay time			150	-	ns	
tf	Fall time	load" and Figure 19: "Switching time waveform")	-	9	-	ns	

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⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% VDSS

Table 7: Source drain diode

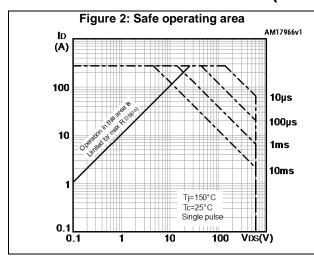
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		ı		68	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		272	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 68 \text{ A}, V_{GS} = 0$	ı	0.98	1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 68 A,	ı	520		ns
Qrr	Reverse recovery charge	$di/dt = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V}$	ı	12		μC
I _{RRM}	Reverse recovery current	(see Figure 18: "Unclamped inductive waveform")	-	45		Α
t _{rr}	Reverse recovery time	I _{SD} = 68 A,	-	680		ns
Qrr	Reverse recovery charge	$di/dt = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$	1	18		μC
I _{RRM}	Reverse recovery current	(see Figure 18: "Unclamped inductive waveform")	-	50		Α

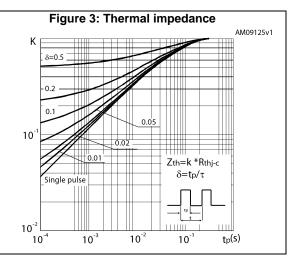
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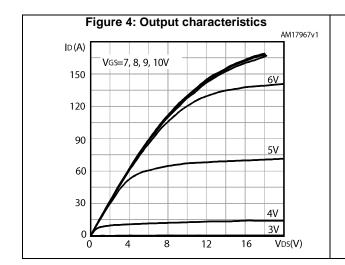
⁽¹⁾Pulse width limited by safe operating area

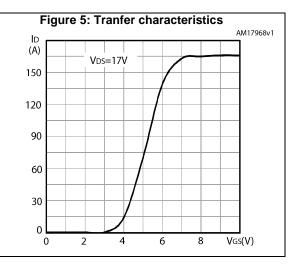
 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

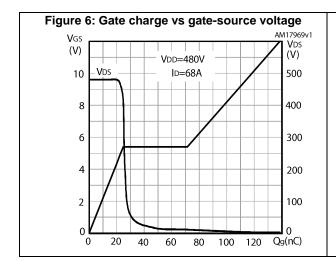
2.1 Electrical characteristics (curve)

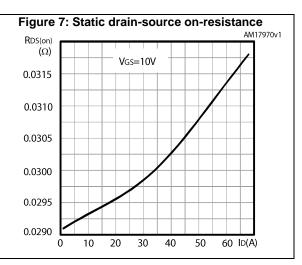




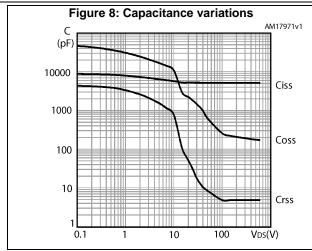








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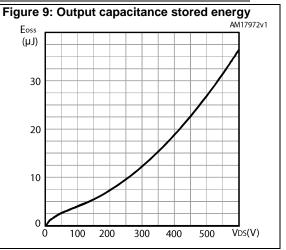


Figure 10: Normalized gate threshold voltage vs temperature

VGS(th)
(norm)

1.1

0.9

0.8

0.7

0.6

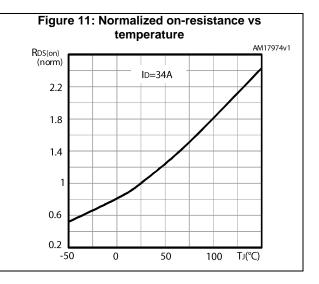
-50

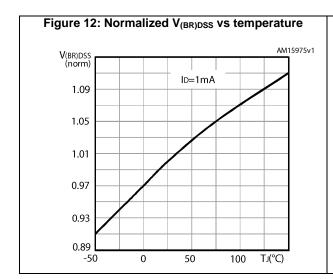
0

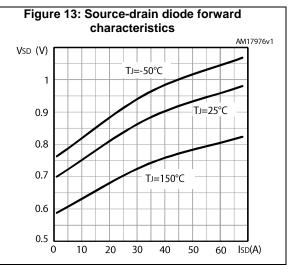
50

100

TJ(°C)

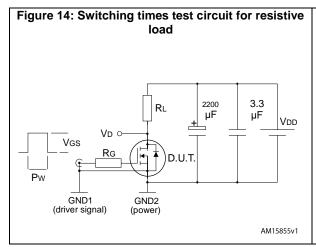


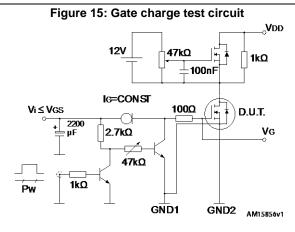


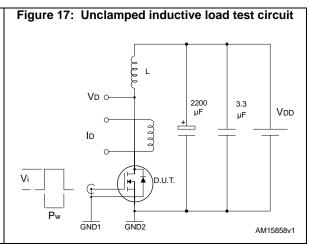


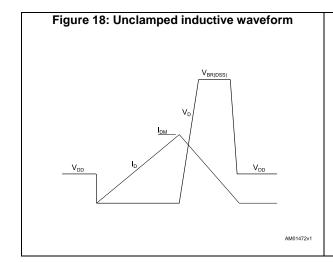
Test circuits STW70N60M2-4

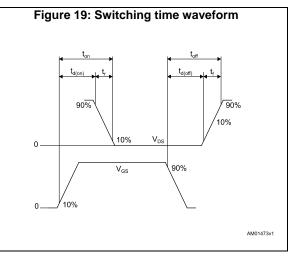
3 Test circuits











4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO247-4 package information

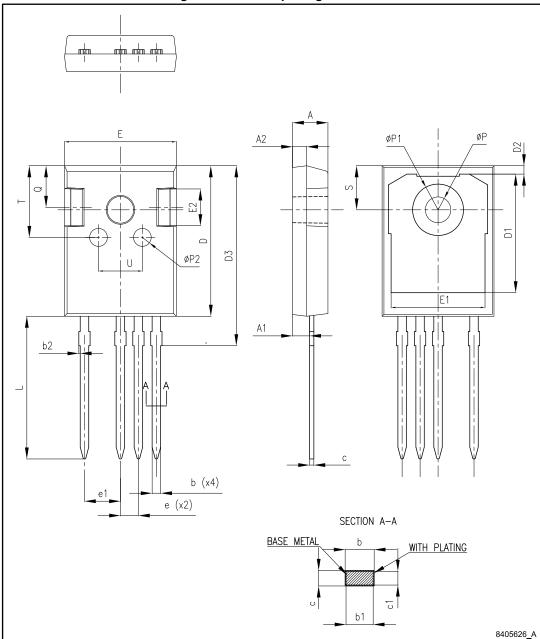


Figure 20: TO247-4 package outline

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Table 8: TO247-4 mechanical data

Table 8: TO247-4 mechanical data						
Dim.		mm				
Diiii.	Min.	Тур.	Max.			
А	4.90	5.00	5.10			
A1	2.31	2.41	2.51			
A2	1.90	2.00	2.10			
b	1.16		1.29			
b1	1.15	1.20	1.25			
b2	0		0.20			
С	0.59		0.66			
c1	0.58	0.60	0.62			
D	20.90	21.00	21.10			
D1	16.25	16.55	16.85			
D2	1.05	1.20	1.35			
D3	24.97	25.12	25.27			
E	15.70	15.80	15.90			
E1	13.10	13.30	13.50			
E2	4.90	5.00	5.10			
E3	2.40	2.50	2.60			
е	2.44	2.54	2.64			
e1	4.98	5.08	5.18			
L	19.80	19.92	20.10			
Р	3.50	3.60	3.70			
P1			7.40			
P2	2.40	2.50	2.60			
Q	5.60		6.00			
S		6.15				
Т	9.80		10.20			
U	6.00		6.40			

STW70N60M2-4 Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
26-Sep-2016	1	Initial release.

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